Octal bus switch
Rev. 3 — 5 January 2012

Product data sheet

#### 1. **General description**

The CBT3245A provides eight bits of high-speed TTL-compatible bus switching. The low ON resistance of the switch allows connections to be made with minimal propagation delay.

The CBT3245A is organized as one 8-bit bus switches with one output enable (OE) input. When  $\overline{OE}$  is LOW, the switch is on and port A is connected to the B port. When  $\overline{OE}$  is HIGH, each switch is disabled. The CBT3245A is characterized for operation from -40 °C to +85 °C.

#### **Features and benefits** 2.

- $\blacksquare$  5  $\Omega$  switch connection between two ports
- TTL-compatible control input levels
- Multiple package options
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115B exceeds 150 V
  - ◆ CDM JESD22-C101C exceeds 1000 V

# Ordering information

Table 1. **Ordering information** 

| Type number | Package           |           |   |          |
|-------------|-------------------|-----------|---|----------|
|             | Temperature range | Name      | Description   | Version  |
| CBT3245AD   | –40 °C to +85 °C  | SO20      | plastic small outline package; 20 leads; body width 7.5 mm  | SOT163-1 |
| CBT3245ADB  | –40 °C to +85 °C  | SSOP20    | plastic shrink small outline package; 20 leads; body width 5.3 mm   | SOT339-1 |
| CBT3245ADS  | –40 °C to +85 °C  | SSOP20[1] | plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm  | SOT724-1 |
| CBT3245APW  | –40 °C to +85 °C  | TSSOP20   | plastic thin shrink small outline package; 20 leads; body width 4.4 mm  | SOT360-1 |
| CBT3245ABQ  | –40 °C to +85 °C  | DHVQFN20  | plastic dual-in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5\times4.5\times0.85~\text{mm}$ | SOT764-1 |

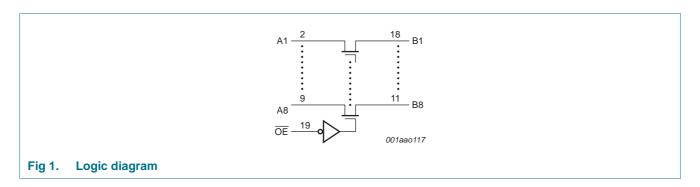
<sup>[1]</sup> Also known as QSOP20 package



**CBT3245A** 

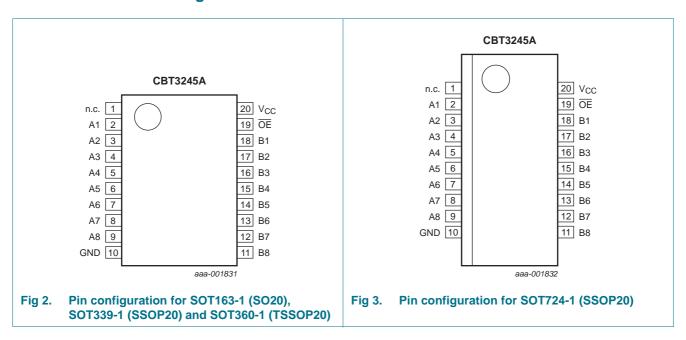
Octal bus switch

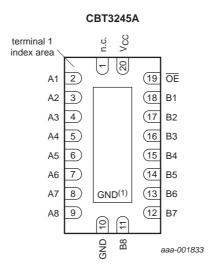
# 4. Functional diagram



# 5. Pinning information

### 5.1 Pinning





Transparent top view

(1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND.

Fig 4. Pin configuration for SOT764-1 (DHVQFN20)

### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin                            | Description                      |
|-----------------|--------------------------------|----------------------------------|
| n.c.            | 1                              | not connected                    |
| A1 to A8        | 2, 3, 4, 5, 6, 7, 8, 9         | data input/output (A port)       |
| GND             | 10                             | ground (0 V)                     |
| B1 to B8        | 18, 17, 16, 15, 14, 13, 12, 11 | data input/output (B port)       |
| OE              | 19                             | output enable input (active LOW) |
| V <sub>CC</sub> | 20                             | positive supply voltage          |

# 6. Functional description

Table 3. Function selection[1]

| Input<br>OE | Input/output |
|-------------|--------------|
| OE          | An, Bn       |
| L           | An = Bn      |
| Н           | Z            |

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

### 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).[1]

 $T_{amb} = -40$  °C to +85 °C, unless otherwise specified.

|                  | •                       |                      |                 |      |      |
|------------------|-------------------------|----------------------|-----------------|------|------|
| Symbol           | Parameter               | Conditions           | Min             | Max  | Unit |
| $V_{CC}$         | supply voltage          |                      | -0.5            | +7.0 | V    |
| $V_{I}$          | input voltage           |                      | <u>[2]</u> –0.5 | +7.0 | V    |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < 0 V | -50             | -    | mA   |
| Vo               | output voltage          |                      | <u>[2]</u> –0.5 | +7.0 | V    |
| I <sub>O</sub>   | output current          | V <sub>O</sub> < 0 V | -               | ±128 | mA   |
| I <sub>IK</sub>  | input clamping current  | $V_I = 0 V$          | -50             | -    | mA   |
| T <sub>stg</sub> | storage temperature     |                      | -65             | +150 | °C   |

<sup>[1]</sup> Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under <a href="Section 8">Section 8</a>. is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 8. Recommended operating conditions

#### Table 5. Operating conditions

All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation.

| Symbol           | Parameter                | Conditions            | Min | Тур | Max | Unit |
|------------------|--------------------------|-----------------------|-----|-----|-----|------|
| $V_{CC}$         | supply voltage           |                       | 4.0 | -   | 5.5 | V    |
| $V_{IH}$         | HIGH-level input voltage |                       | 2.0 | -   | -   | V    |
| V <sub>IL</sub>  | LOW-level input voltage  |                       | -   | -   | 0.8 | V    |
| T <sub>amb</sub> | ambient temperature      | operating in free air | -40 | -   | +85 | °C   |

### 9. Static characteristics

#### Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol               | Parameter                          | Conditions  | T <sub>amb</sub> = | –40 °C to - | ⊦85 °C | Unit |
|----------------------|------------------------------------|---|--------------------|-------------|--------|------|
|                      |                                    |   | Min                | Typ[1]      | Max    |      |
| $V_{IK}$             | input clamping voltage             | $V_{CC} = 4.5 \text{ V}; I_{I} = -18 \text{ mA}$  | -                  | -           | -1.2   | V    |
| I                    | input leakage current              | $V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$                                  | -                  | -           | ±5     | μΑ   |
| I <sub>CC</sub>      | supply current                     | $V_{CC}$ = 5.5 V; $I_O$ = 0 mA;<br>$V_I$ = $V_{CC}$ or GND                                    | -                  | 1           | 3      | μΑ   |
| $\Delta I_{CC}$      | additional supply current          | per input pin; $V_{CC} = 5.5 \text{ V}$ ; one input at 3.4 V, other inputs at $V_{CC}$ or GND | -                  | -           | 3.5    | mA   |
| Cı                   | input capacitance                  | control pins; V <sub>I</sub> = 3 V or 0 V   | -                  | 3.2         | -      | pF   |
| $C_{\text{io(off)}}$ | off-state input/output capacitance | port off; $V_1 = 3 \text{ V or } 0 \text{ V}; \overline{OE} = V_{CC}$                         | -                  | 6.6         | -      | pF   |

<sup>[2]</sup> The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

 Table 6.
 Static characteristics ...continued

Voltages are referenced to GND (ground = 0 V).

| Symbol   | Parameter     | Conditions   |     | T <sub>amb</sub> = | -40 °C to ⋅ | Unit |   |
|----------|---------------|--|-----|--------------------|-------------|------|---|
|          |               |  |     | Min                | Typ[1]      | Max  |   |
| $R_{ON}$ | ON resistance | $V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 64 \text{ mA}$ | [3] | -                  | 5           | 7    | Ω |
|          |               | $V_{CC} = 4.5 \text{ V}; V_I = 0 \text{ V}; I_I = 30 \text{ mA}$ | [3] | -                  | 5           | 7    | Ω |
|          |               | $V_{CC}$ = 4.5 V; $V_I$ = 2.4 V; $I_I$ = -15 mA                  | [3] | -                  | 10          | 15   | Ω |

<sup>[1]</sup> All typical values are at  $V_{CC}$  = 5 V,  $T_{amb}$  = 25 °C.

## 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

| Symbol           | Parameter         | Conditions                                 | $T_{amb} = -40$ | Unit |      |    |
|------------------|-------------------|--|-----------------|------|------|----|
|                  |                   |  |                 | Min  | Max  |    |
| t <sub>pd</sub>  | propagation delay | An, Bn to Bn, An; see Figure 5             | [1][2]          |      |      |    |
|                  |                   | $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ |                 | -    | 0.25 | ns |
| t <sub>en</sub>  | enable time       | OE to An or Bn; see Figure 6               | [2]             |      |      |    |
|                  |                   | $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ |                 | 1.0  | 5.9  | ns |
| t <sub>dis</sub> | disable time      | OE to An or Bn; see Figure 6               | [2]             |      |      |    |
|                  |                   | $V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$ |                 | 1.0  | 6.0  | ns |

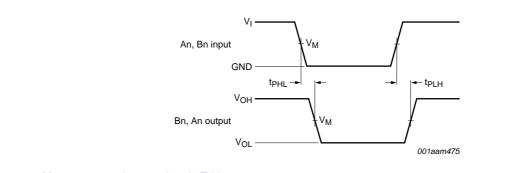
<sup>[1]</sup> The propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified load capacitance, when driven by an ideal voltage source (zero output impedance).

<sup>[2]</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

<sup>[3]</sup> Measured by the voltage drop between the An and the Bn terminals at the indicated current through the switch. ON resistance is determined by the lowest voltage of the two (An or Bn) terminals.

 $<sup>\</sup>begin{array}{ll} \hbox{ [2]} & t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}. \\ & t_{en} \text{ is the same as } t_{PZL} \text{ and } t_{PZH}. \\ & t_{dis} \text{ is the same as } t_{PLZ} \text{ and } t_{PHZ}. \end{array}$ 

### 11. Waveforms



Measurement points are given in Table 8.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. The data input (An, Bn) to output (Bn, An) propagation delay times

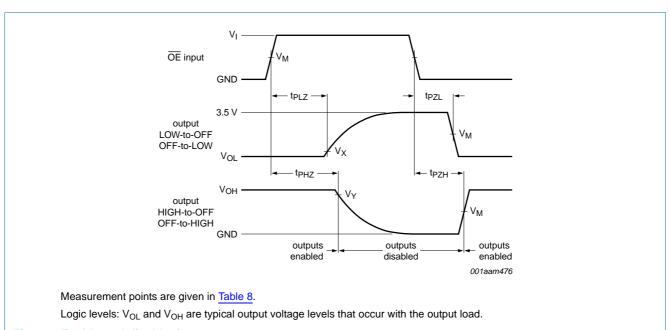
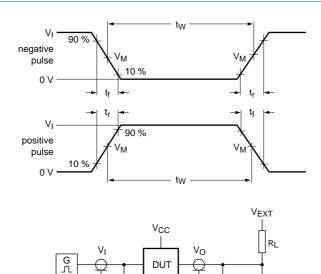


Fig 6. Enable and disable times

Table 8. Measurement points

| Supply voltage               | Input        |                | Output         |                         |                 |  |  |  |  |
|------------------------------|--------------|----------------|----------------|-------------------------|-----------------|--|--|--|--|
| V <sub>CC</sub>              | VI           | V <sub>M</sub> | V <sub>M</sub> | $V_X$                   | V <sub>Y</sub>  |  |  |  |  |
| $V_{CC}$ = 5.0 V $\pm$ 0.5 V | GND to 3.0 V | 1.5 V          | 1.5 V          | V <sub>OL</sub> + 0.3 V | $V_{OH}-0.3\ V$ |  |  |  |  |

### 12. Test information



Test data is given in Table 9.

All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz;  $Z_0 = 50~\Omega$ .

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The outputs are measured one at a time with one transition per measurement.

Definitions for test circuit:

 $R_L$  = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{\text{EXT}}$  = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

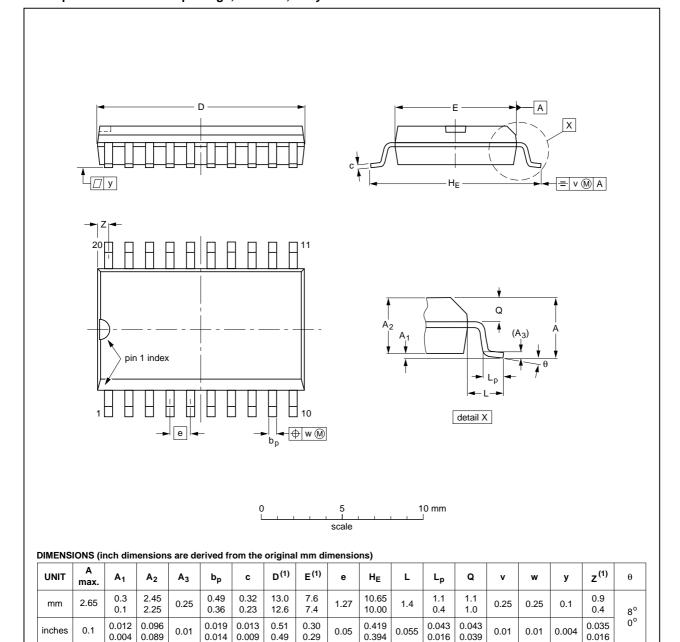
Table 9. Test data

| Supply voltage               | Input        |                                 | Load  |                | V <sub>EXT</sub>                    |                                     |                                     |  |
|------------------------------|--------------|---------------------------------|-------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|--|
|                              | VI           | t <sub>r</sub> , t <sub>f</sub> | CL    | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PLZ</sub> , t <sub>PZL</sub> | t <sub>PHZ</sub> , t <sub>PZH</sub> |  |
| $V_{CC}$ = 5.0 V $\pm$ 0.5 V | GND to 3.0 V | $\leq$ 2.5 ns                   | 50 pF | 500 Ω          | open                                | 7.0 V                               | open                                |  |

## 13. Package outline

### SO20: plastic small outline package; 20 leads; body width 7.5 mm

#### SOT163-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE  |        | REFER  | ENCES | EUROPEAN   | AN ISSUE DATE                   |  |  |  |
|----------|--------|--------|-------|------------|---------------------------------|--|--|--|
| VERSION  | IEC    | JEDEC  | JEITA | PROJECTION | ISSUE DATE                      |  |  |  |
| SOT163-1 | 075E04 | MS-013 |       |            | <del>99-12-27</del><br>03-02-19 |  |  |  |

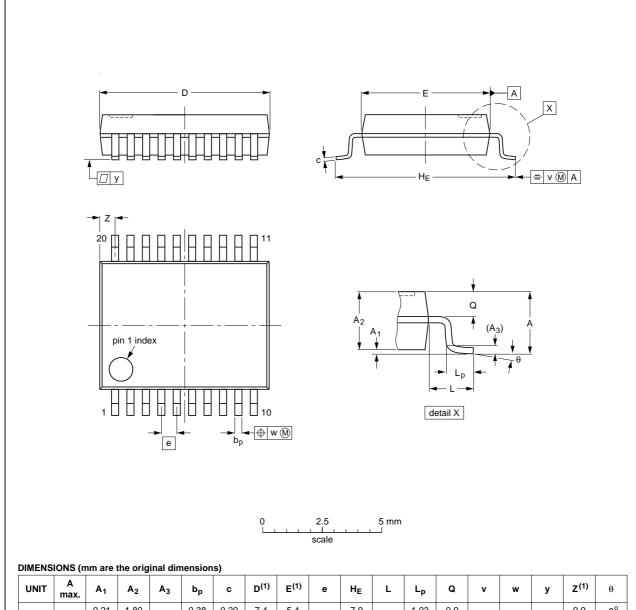
Fig 8. Package outline SOT163-1 (SO20)

CBT3245A

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### SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | ø          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25           | 0.38<br>0.25 | 0.20<br>0.09 | 7.4<br>7.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 0.9<br>0.5       | 8°<br>0° |

#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

| OUTLINE  |     | REFER  | EUROPEAN | ISSUE DATE |            |                                 |
|----------|-----|--------|----------|------------|------------|---------------------------------|
| VERSION  | IEC | JEDEC  | JEITA    |            | PROJECTION | ISSUE DATE                      |
| SOT339-1 |     | MO-150 |          |            |            | <del>99-12-27</del><br>03-02-19 |
| -        | -   |        |          | -          |            |                                 |

Fig 9. Package outline SOT339-1 (SSOP20)

CBT3245A

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#### SSOP20: plastic shrink small outline package; 20 leads; body width 3.9 mm; lead pitch 0.635 mm SOT724-1

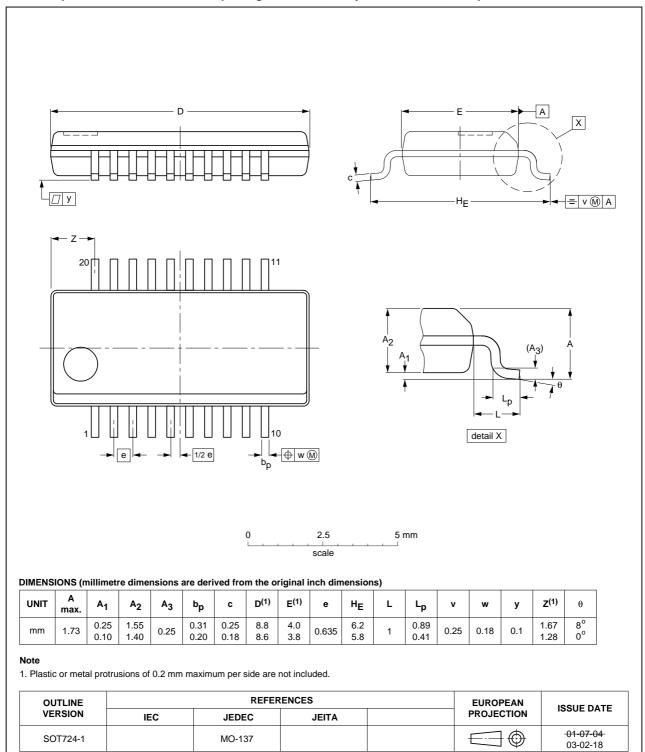
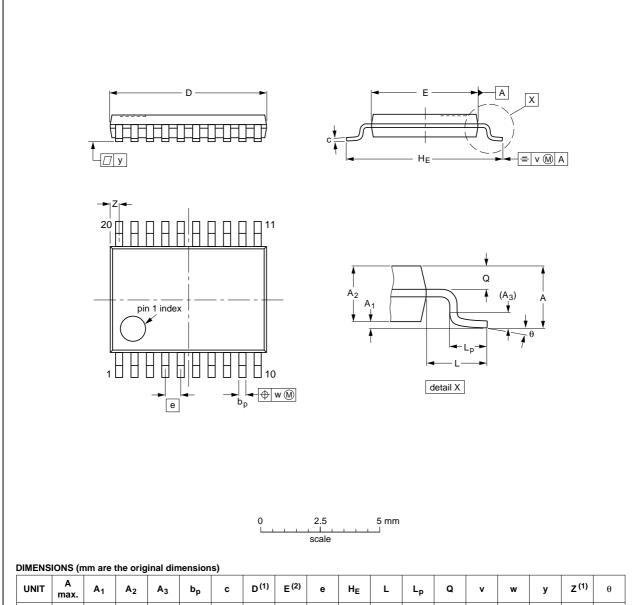


Fig 10. Package outline SOT724-1 (SSOP20)

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E <sup>(2)</sup> | е    | HE         | L | Lp           | ø          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|----------------|--------------|------------|------------------|------------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 1.1       | 0.15<br>0.05   | 0.95<br>0.80   | 0.25           | 0.30<br>0.19 | 0.2<br>0.1 | 6.6<br>6.4       | 4.5<br>4.3       | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.5<br>0.2       | 8°<br>0° |

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE  | REFERENCES |        |       |  | EUROPEAN   | ISSUE DATE                       |  |
|----------|------------|--------|-------|--|------------|----------------------------------|--|
| VERSION  | IEC        | JEDEC  | JEITA |  | PROJECTION | ISSUE DATE                       |  |
| SOT360-1 |            | MO-153 |       |  |            | <del>-99-12-27</del><br>03-02-19 |  |
|          |            |        |       |  |            |                                  |  |

Fig 11. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

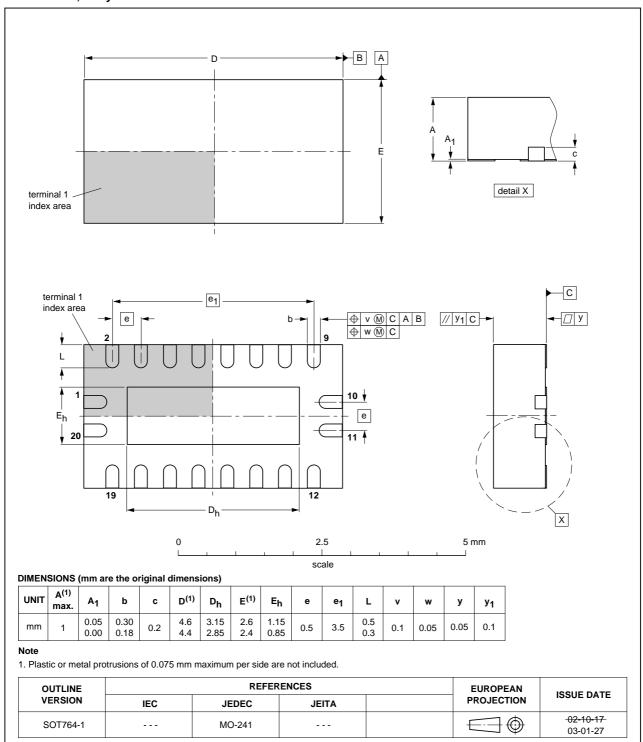


Fig 12. Package outline SOT764-1 (DHVQFN20)

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## 14. Abbreviations

### Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| ESD     | ElectroStatic Discharge     |
| DUT     | Device Under Test           |
| НВМ     | Human Body Model            |
| MM      | Machine Model               |
| PRR     | Pulse Rate Repetition       |
| TTL     | Transistor-Transistor Logic |

# 15. Revision history

### Table 11. Revision history

| Document ID    | Release date  | Data sheet status                                      | Change notice        | Supersedes   |  |  |  |  |  |
|----------------|---|--|----------------------|--------------|--|--|--|--|--|
| CBT3245A v.3   | 20120105  | Product data sheet                                     | -                    | CBT3245A v.2 |  |  |  |  |  |
| Modifications: | <ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of<br/>NXP Semiconductors.</li> </ul> |  |                      |              |  |  |  |  |  |
|                | <ul> <li>Legal texts</li> </ul>   | have been adapted to the ne                            | w company name where | appropriate. |  |  |  |  |  |
|                | <ul> <li>Marking code removed from order information section.</li> </ul>  |  |                      |              |  |  |  |  |  |
|                | <ul> <li>Description</li> </ul>   | of C <sub>I</sub> and C <sub>I/O</sub> corrected (erra | ata).                |              |  |  |  |  |  |
| CBT3245A v.2   | 20020627  | Product data sheet                                     | -                    | CBT3245A v.1 |  |  |  |  |  |
| CBT3245A v.1   | 20020218  | Product data sheet                                     | -                    | -            |  |  |  |  |  |
| -              |   |  |                      |              |  |  |  |  |  |

### 16. Legal information

#### 16.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design
- [2] The term 'short data sheet' is explained in section "Definitions"
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#### Octal bus switch

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